

Title (en)
COMPACT OPTOELECTRONIC MODULES

Title (de)
KOMPAKTE OPTOELEKTRONISCHE MODULE

Title (fr)
MODULES OPTOÉLECTRONIQUES COMPACTS

Publication
EP 3072155 A4 20170503 (EN)

Application
EP 14863553 A 20141118

Priority
• US 201361907485 P 20131122
• SG 2014000543 W 20141118

Abstract (en)
[origin: WO2015076750A1] Compact optoelectronic modules are described that, in some implementations, can have reduced heights, while at the same time having very little optical crosstalk or detection of stray light. An optoelectronic module having optical channel can include a support on which is mounted an optoelectronic device arranged to emit or detect light at a particular one or more wavelengths. The module has a cover including an optically transmissive portion over the optoelectronic device. The optically transmissive portion is surrounded laterally by sections of the cover that are substantially non-transparent to the one or more wavelengths. A passive optical element is present on a surface of the optically transmissive portion. A spacer separates the support from the cover. The cover can be relatively thin so that the overall height of the module is relatively small.

IPC 8 full level
H01L 27/146 (2006.01); **G01S 7/481** (2006.01); **H01L 23/00** (2006.01); **H01L 25/00** (2006.01); **H01L 31/0232** (2014.01); **H01L 31/167** (2006.01); **H01L 31/173** (2006.01); **H01L 33/44** (2010.01); **H01L 33/48** (2010.01); **H01L 25/16** (2006.01)

CPC (source: EP KR US)
B29D 11/00307 (2013.01 - EP); **G01S 7/4813** (2013.01 - EP KR US); **H01L 24/97** (2013.01 - EP KR US); **H01L 25/167** (2013.01 - EP KR US); **H01L 25/50** (2013.01 - US); **H01L 27/14618** (2013.01 - EP KR US); **H01L 31/02325** (2013.01 - EP KR US); **H01L 31/167** (2013.01 - EP KR US); **H01L 31/173** (2013.01 - US); **H01L 33/44** (2013.01 - EP US); **H01L 33/486** (2013.01 - EP US); **H01L 2924/0002** (2013.01 - EP US); **H01L 2924/12041** (2013.01 - KR US); **H01L 2924/12042** (2013.01 - US); **H01L 2924/12043** (2013.01 - EP KR US); **H01L 2924/12044** (2013.01 - EP US)

C-Set (source: EP US)
EP
1. **H01L 2924/12043** + **H01L 2924/00**
2. **H01L 2924/12044** + **H01L 2924/00**
US
1. **H01L 2924/0002** + **H01L 2924/00**
2. **H01L 2924/12043** + **H01L 2924/00**
3. **H01L 2924/12044** + **H01L 2924/00**

Citation (search report)
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• [IA] EP 2472294 A1 20120704 - SHINKO ELECTRIC IND CO [JP]
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EP3806170A4; EP3806170B1

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AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

DOCDB simple family (publication)
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